

SiW-ECAL Beam test 2015 Kick-Off meeting

Vincent Boudry

École polytechnique, Palaiseau

Agenda

Goal of meeting:

- information on project, preparation of participation, organisation

Physics program

Technical Status:

- HW, SW, DAQ, Online Analysis

Practical details:

- €€€, Logistics, Shift plans

Organisational issues

AoB

(prelim) Physics program

Physics commissioning:

- Check proper running with high intensity μ 's (X-check of cosmics)
- Thr. adjustment vs noise environment. (Maybe require shielding).

EM-Core Set-up: All slabs after $5 X_0$ of W \rightarrow Strong correlation between SLAB's

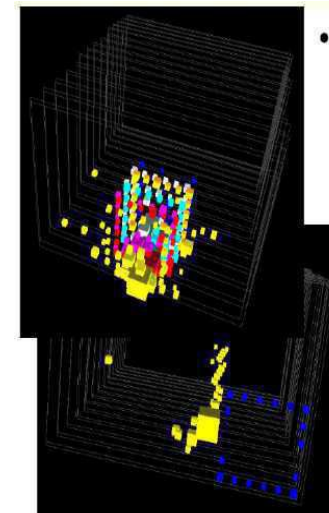
- Response at the core of a EM shower:
 - Explore the full dynamic range (1–2500 mips) using shower profile (for all mem depth).
 - e^- runs of all energies, beam rates \rightarrow linearity
 - Check the responses at the wafers edges with \neq types of wafers (square events)
 - Scan in positions

HAD-Core set-up: same as EM-core or with 1λ of W / SS

- Response to HE hadrons: look for SEU

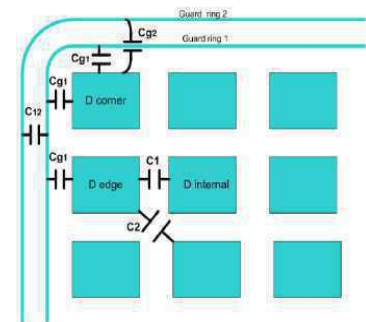
Mini-ECAL set-up: Sampling with $3-4 \times 2.5 X_0$ and $2-3 \times 5 X_0$

- Study of theoretical resolution & simulation tuning.
 - Scan in energy, position (and angle).



• “Square events”

- cross talk between guard rings and pixels

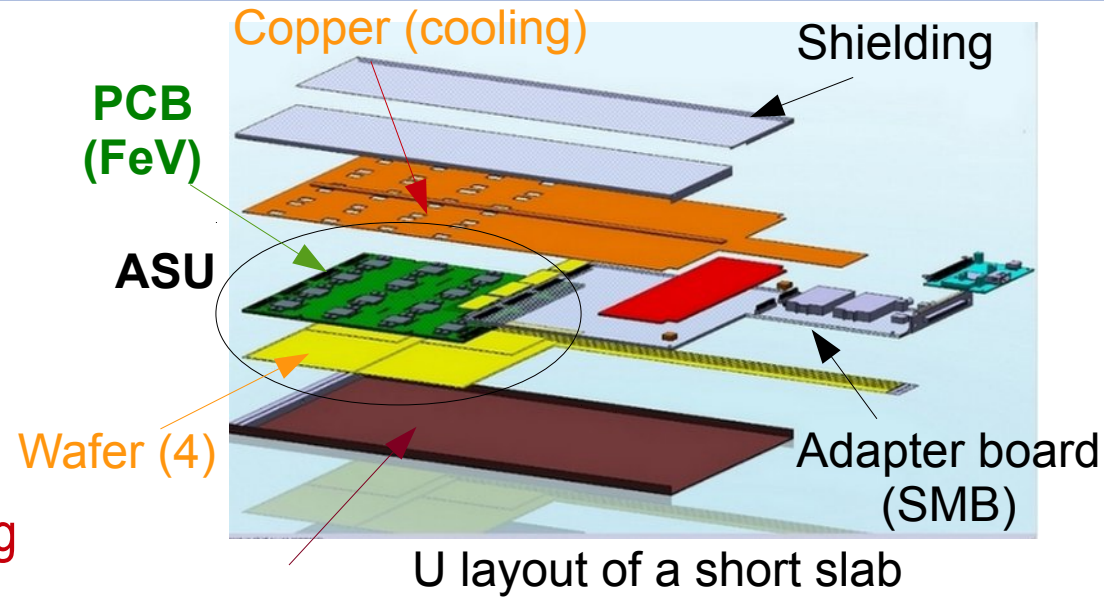


Technical readiness

4 ASU have been produced

- 3 OK: $\leq 5\mu\text{A}$ of consumption @ full depletion
- 1 was leaking.
I \searrow $15\mu\text{A}$ after a month of conditioning
- OK for 3 additionnal ones, including “Edgeless Wafers” (no GR).

Being tested on test plates



Technical readiness (2)

Data Taking of Cosmics

- Just started this week with 3 test plates
- Minor issue with 1 contacts on 2 slabs.
 - debugging validation signal missing (need fix in FE FW || rec code)

4th plate being prepared

Assembly procedure in SLAB to be assessed
end of September & beg of October



DAQ & Analysis

DAQ HW & FW (LDA, GDCC, DIF)

- no crash in months
- tested in heavy operation (sim)

DAQ SW

- Low level: (CALICOES & PYRAME)
 - > config management: ready
- Event Builder being tested

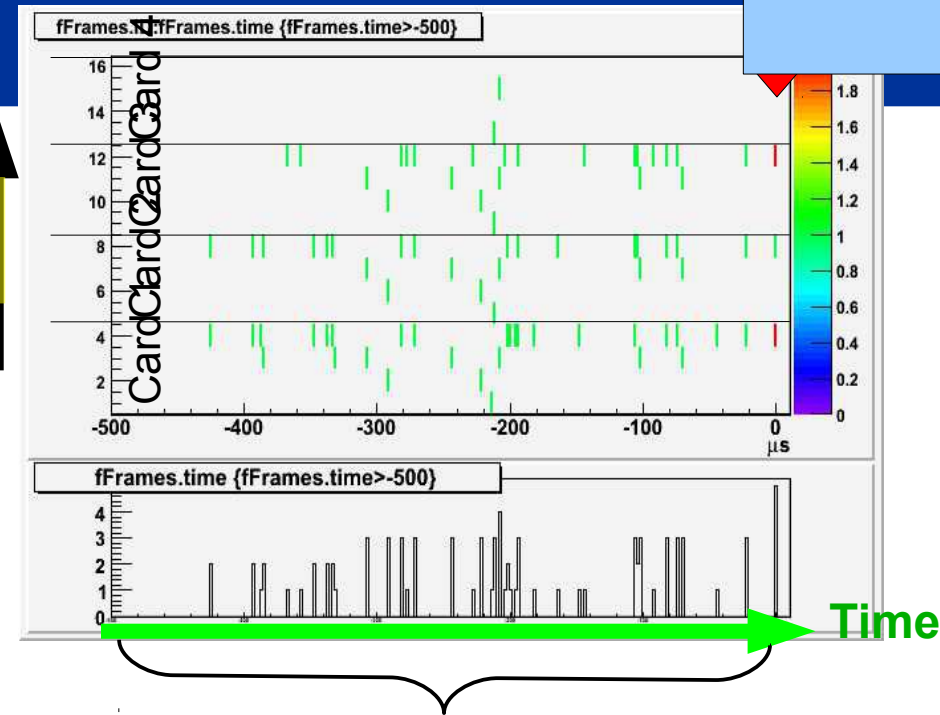
Higher level SW (RunDB, online monitoring)

- being worked on

Analysis:

- Automatic thr. determination
 - several procedures: being X-checked

ASIC #
(4 / Card)



1 Spill (DAQ)

Sync on « end signal (TB mode) or Start ILC mode

ILC mode (triggerless with delayed readout)

- 20% duty cycle during SPS spills
 - depends on noise & type of events

TB on CMS beam line

SPS: November 2015



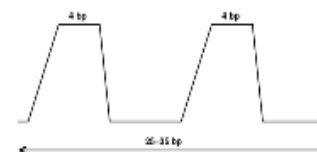
schedule issue date: 01-Sep-2015

Version: 2.5.4

		Mon 2 Nov	Tue 3 Nov	Wed 4 Nov	Thu 5 Nov	Fri 6 Nov	Sat 7 Nov	Sun 8 Nov	Mon 9 Nov	Tue 10 Nov	Wed 11 Nov	Thu 12 Nov	Fri 13 Nov	Sat 14 Nov	Sun 15 Nov	Mon 16 Nov	Tue 17 Nov	Wed 18 Nov	Thu 19 Nov	Fri 20 Nov	Sat 21 Nov	Sun 22 Nov	Mon 23 Nov	Tue 24 Nov	Wed 25 Nov	Thu 26 Nov	Fri 27 Nov	Sat 28 Nov	Sun 29 Nov	Mon 30 Nov	Tue 1 Dec	Wed 2 Dec	Thu 3 Dec	Fri 4 Dec	Sat 5 Dec	Sun 6 Dec
Week		45							46							47							48							49						
Machine		UA9							Coldex							setup							UA9													
North Area	T2 - H2	NA61 SHINE		D. Lazic PPE172		CMS ECAL										A. Aduszkiewicz PPE152		NA61 SHINE																		
	T2 - H4	RD51 (+GIF)		G. Mallot PPE134		NA58 ECAL					H. Dong PPE134		HERD			NUCLEON			D. Emschermann PPE134		RE21 CBM															
	T4 - H6	ALICE FOCAL		D. Lazic PPE156 EUDET		CMS Outer Tracker																														
	T4 - H8	RD52 DREAM		H. Schindler PPE138		LHCb					UA9		RE29 DAMPE			RE25 CALET/SuperTIGER																				
	T4 - K12	A. Ceccucci		NA62																																
	T6 - M2	J. Bernhard		NA58 COMPASS																																

For further information contact the PS/SPS-Coordinator. Email: Sps.Coordinator@cern.ch, Tel: +41 75 411 3845.

The latest version of the schedule are available here: <http://sps-schedule.web.cern.ch/sps-schedule/>
 This schedule is synchronized with injector schedule v1.10
 2 extractions with a 4.8s(4bp) flat top per supercycle.
 No beam during Technical Stops (TS) and Machine Developments (MD)
 For TS a cool down time is needed and will be announced in the days preceding the stop.

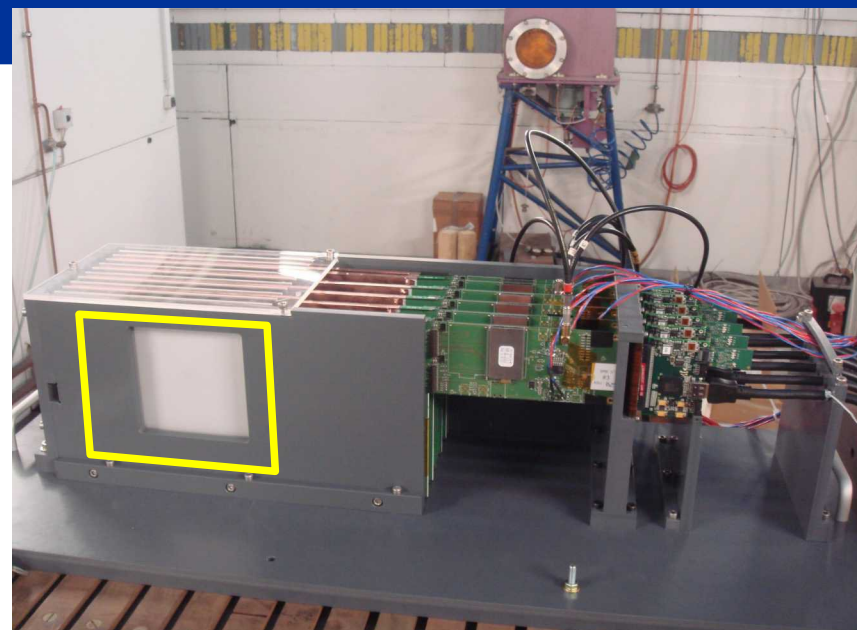


Set-up

For SLAB's:

Re-use the DESY structure (could be an issue @ CERN)

- with increased opening for $18 \times 18 \text{ cm}^2$.
- (x, y) Moveable table ($20 \times 20 \text{ cm}^2$ in range)
~ 100kg
- Absorbers ($5X_0$ of W and/or 1λ of W or SS)
in front.



(Beam hodoscope for beam monitoring)

- eventually in “BC” particule time-stamping
(special device needed).

Backup plans (if SLAB assembly schedule is too tight)

Aluminium testboard's:
($0.25 X_0$)

- Vertical stand needed (in design)



Admin

Green light: end of August (D. Lazic)

Schedule:

- beam line: H2 from Nov wed. 4th– Mon 16th.
 - 2–3 days for in-beam commissioning (engineers)
 - 9-10 days of running

Participation

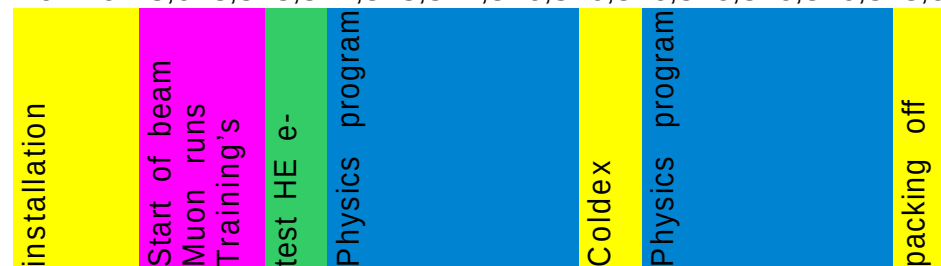
- ILC: LLR, LAL, LPNHE, LPSC, KYUSHU
- CMS: LLR, Imperial, (CERN)

Support:

- AIDA-2020 TNA
- Needs help from IN2P3 (TB was not scheduled for this year).

TB & Shifts Plans (prelim)

Name	Lab	Status (Perm, PD,	Days																
				mer. 07	lun. 02	03	mer. 04	05	ven. 06	07	08	lun. 09	10	mer. 11	12	13	14	15	lun. 16
V. Boudry (lead)	LLR	Perm	15	1	///	1	1	1	1	1	1	1	1	1	1	1	1	1	1
V. Balagura (coord.)	LLR	Perm	15	1	///	1	1	1	1	1	1	1	1	1	1	1	1	1	1
M. Frotin	LLR	Perm	3	1	///	1	1	1											
Meca LPNHE ?	LPNHE	Ing	3		///	1	1	1											
J. Nanny	LLR	Ing	7	1	///	1	1	1	1	1	1	1							
R. Cornat (Tech.)	LLR	Ing	2		///	///	///	///	///	///	1	1	///						
F. Magniette MR	LLR	Ing	5		///	1	1	1	1	1									
K. Shpak	LLR	PhD	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
D. Yu	LLR	PhD	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
R. Poeschl	LAL	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
D. Zerwas	LAL	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
S. Bilokin	LAL	PhD	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
D. Lacour	LPNHE	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
A. Lleres	LPSC	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
C. Ochando ?	LLR	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
R. Salerno ?	LLR	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
Person 1	IC		4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
Person 2 ?	IC	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
T. Suehera	Kyushu	Perm	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
Student ?	Kyushu	PhD	4		///			1/5	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/3	1/8
Total			101,892	4		6	6	8,6	8,3	8,3	7,3	8,3	7,3	6,3	6,3	6,3	6,3	6,3	3,6



TNA AIDA-2020

Support for the stay of non-CERN and non-swiss participants possible

- <http://aida2020.web.cern.ch/content/cern>
- up-to 138CHF/day, no travel reimbursement

Contacted Henric Wilkens (contact for CERN PS&SPS)

- asked not to go over **~80 days** (for 130 estimated)
 - from lim. for CALICE & 2015

Filling of the demand:

- Names, # of travels, # days, status (Perm, PhD, ...)
- Signature of Agreement @ CERN

Reimbursement by CERN to **individuals** (i.e. not to institutes)

- IBAN's to be provided

Data & Publications

Test of part of device, not a full prototype

⇒ This test will **NOT** be a CALICE one (nor CMS, Atlas...)

Data & Analysis and Publications

internal to the group of participants, based on good will and practises

Pre and Post-Data taking analysis meeting to be set-up

to be started within a month from now (we are in W-7)

Training with analysis SW

Wiki page under construction with all relevant information

Extras

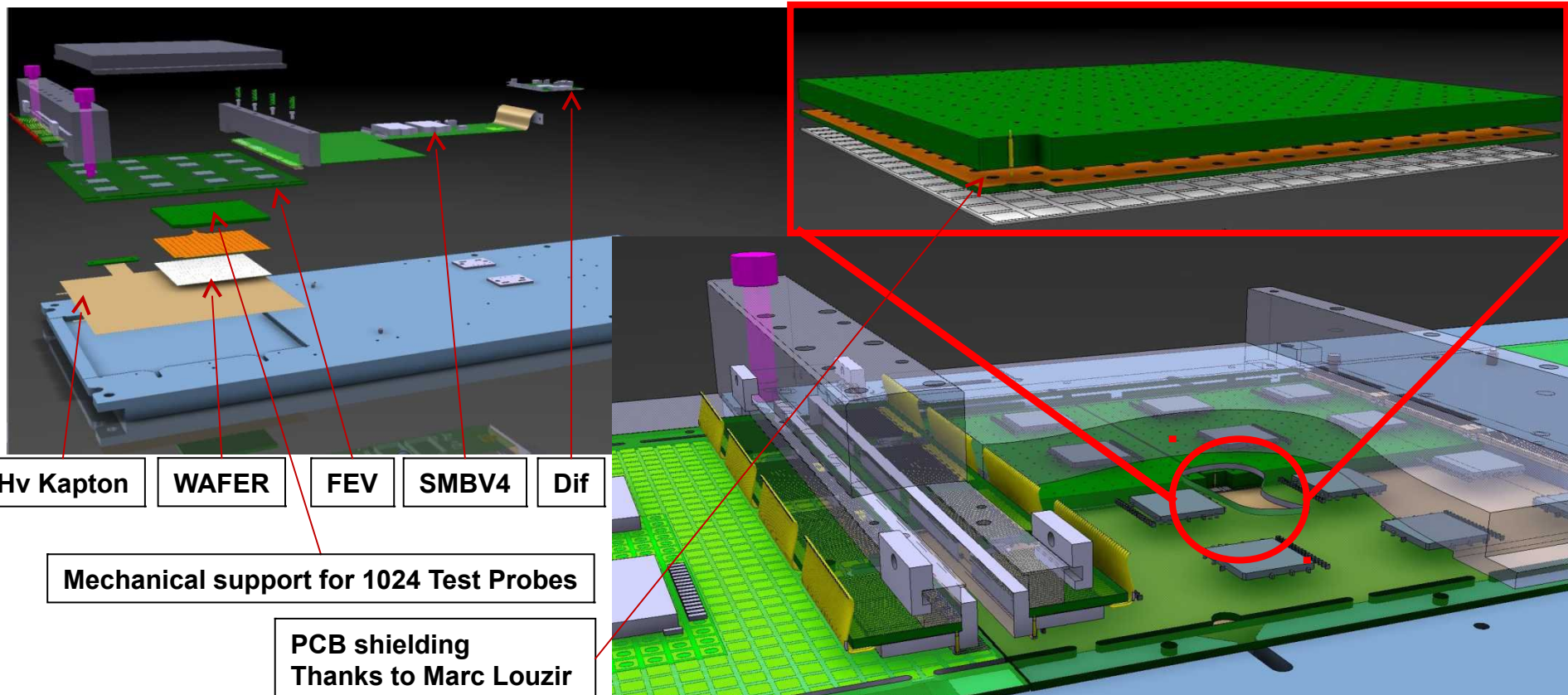
ASU Setup “4 wafers without glue”

Mickael Frotin @ Annecy

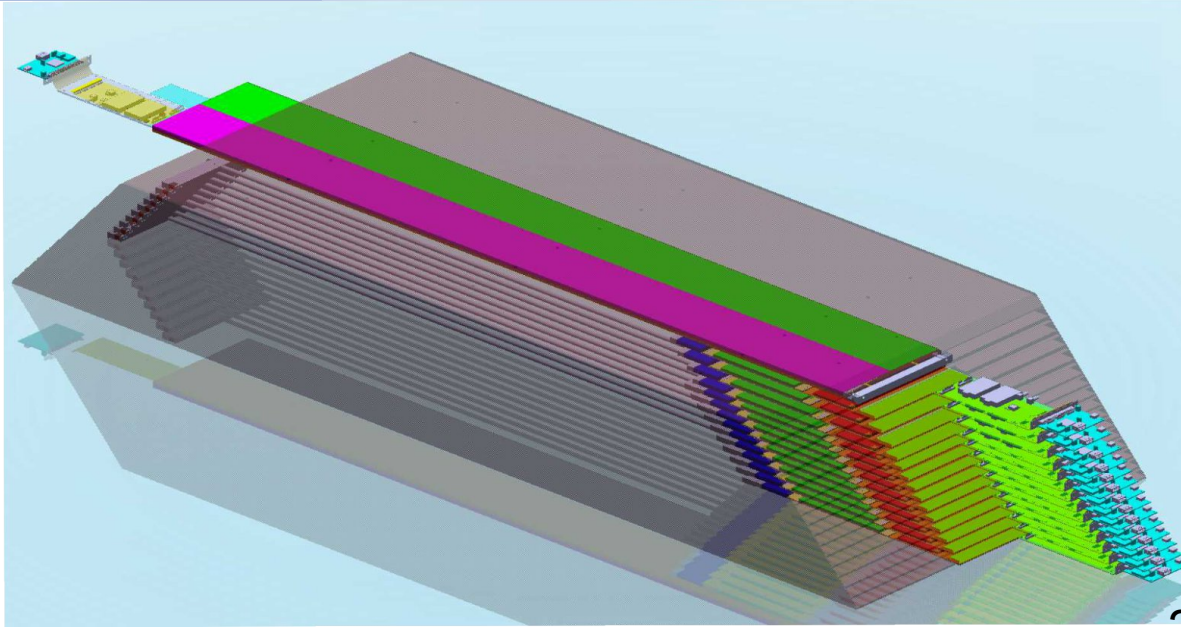
⇒ The goal:

2.0 – Setup option with support of test electric probes for connecting WAFER to FEV

- Realize an assembly with removable wafer in order to acquire cosmic data. This assembly will test the entire acquisition chain (Wafer-FEV-SMBV4-DIF-GDCC-CCC-PC-Software) before the wafer gluing operation. The first test was realized last week



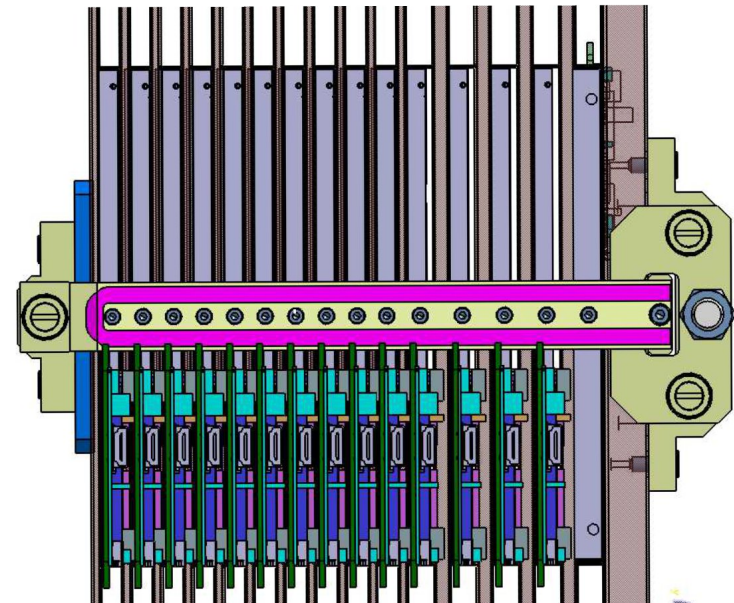
“Final” prototype test (2016+)



Tower of $18 \times 18 \text{ cm}^2$ (2×2 wafers)
14 Short SLABs
1 Long SLAB

$2 \times 2.1 \text{ mm/lay}$

$2 \times 4.2 \text{ mm/lay}$



SLAB's

R&D for “mass production” and QA

- Quality tests & preparation of large production
- Modularity → ASU & SLABs
 - Choice of square wafers (≠ from hex: SiD, CMS HGCal)

Numbers ($R_{\text{ECAL}} = 1,8 \text{ m}$, $|Z_{\text{Endcaps}}| = 2,35 \text{ m}$)
(likely to be reduced by 30–40%)

- **40** Barrel modules: 40 (as of today all identical)
- **24** Endcap Modules: 24 (3 types)
- **9600** Slabs = 6000 (B) + 3600 (EC)
 - many ≠ lengths
- **~75K** ASUs
 - **300K** Wafers (2500 m^2)
 - **1.2M** VFE chips
 - **77M** Channels

